

## Part Number: XZMDKMYKX56W-HTA

3.0x1.0mm High Temperature Series

#### **Features**

- 3.0x1.0x1.5mm right angle SMD LED
- Ideal for indication on hand held products
- Low current operation
- $\bullet$  Standard Package: 2,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- Halogen-free
- RoHS compliant





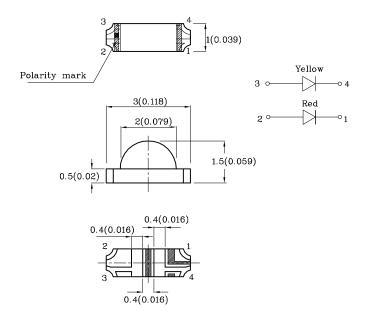


ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

# **Applications**

- Backlighting for tell-tale indicators
- Dashboard lighting
- Interior lighting (footwell, dome light, accent lighting, etc.)
- Exterior lighting (turn signals, side markers, CHMSL, etc.)
- Signs and signals
- Various applications requiring high temperature rating

# Package Schematics



#### Notes

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm$  0.2(0.008") unless otherwise noted.
- 3. Specifications are subject to change without notice.

Dec 13,2019



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Part Number	Emitting Color	Emitting Material	$\begin{array}{c} {\rm Luminous\ Intensity} \\ {\rm CIE1272007*} \\ {\rm (I_F\text{=-}20mA)} \\ {\rm mcd} \end{array}$			Lens-color	Viewing Angle 20 1/2
			Code.	min.	max.		
			N	120	200		
		AlGaInP	P	200	300	- - - - Water Clear	
	Red		Q	300	400		
	Ked		H*	55*	80*		
			M*	80*	120*		
XZMDKMYKX56W-HTA			N*	120*	200*		
AZMDKW1KA96W-H1A			N	120	200	water Clear	190-
		AlGaInP	P	200	300	- - -	
	Yellow		Q	300	400		
			N*	120*	200*		
			P*	200*	300*		
			Q*	300*	400*	-	

#### Note:

1.01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

# Absolute Maximum Ratings at Ta=25°C

<b>D</b>	G 1.1	Va	TT **		
Parameter	Symbol	Red	Yellow	Unit	
Power dissipation	PD	75	75	mW	
Reverse Voltage	$V_{\mathrm{R}}$	5	5	V	
Junction temperature	ТЈ	115	115	°C	
Operating Temperature	Тор	-40 Te	°C		
Storage Temperature	Tstg	-40 T	°C		
DC Forward Current	IF	30	30	mA	
Peak Forward Current [2]	IFM	185	185 175		
Electrostatic Discharge Threshold (HBM)	3000 3000		V		
Thermal Resistance (Junction/ambient) [1]	Rth j-a	500	710	°C/W	
Thermal Resistance (Junction / Solder point) [1]	Rth j-s	400	600	°C/W	

#### Notes

- 1. Rth(j-a) Results from mounting on PC board FR4 (pad size≥16 mm² per pad),
- 2. 1/10 Duty Cycle, 0.1ms Pulse Width.
- 3. A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Dec 13,2019 XDSB9293 V2-X Layout: Maggie L.

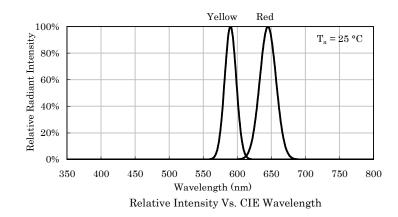
<sup>\*</sup>Luminous intensity value is in accordance with CIE127-2007 standards.

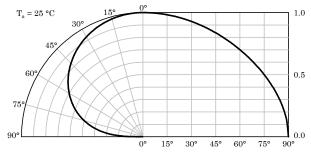
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# Electrical / Optical Characteristics at Ta=25°C

<b>D</b>	G 1 1	CI :		Va	lue		
Parameter	Symbol	Chip	Code.	Min.	Typ.	Max.	Unit
Wavelength at peak emission CIE127-2007* IF = $20mA$	λpeak	Red Yellow	-	-	645* 590*		nm
		Red	-	620*	-	640*	
			3*	586*	-	588*	
Dominant Wavelength CIE127-2007* IF = $20mA$	λdom [1] 4* 588*	-	590*	nm			
		Yellow	5*	590*	-	592*	
			6*	592*	-	594*	
Spectral bandwidth at $50\%\Phi$ REL MAX IF = $20mA$	Δλ	Red Yellow	-	-	28 20	-	nm
Forward Voltage IF = 20mA	VF [2]	Red Yellow	-	-	1.95 2.0	2.5 2.5	V
Reverse Current (VR = 5V)	Ir	Red Yellow	-	-	-	10 10	μА
Temperature coefficient of $\lambda$ peak IF = 20mA, $-10$ °C $\leq$ T $\leq$ 100°C	TCλpeak	Red Yellow	-	-	0.14 0.12	-	nm/°C
Temperature coefficient of $\lambda$ dom IF = 20mA, -10°C $\leq$ T $\leq$ 100°C	TCλdom	Red Yellow	-	-	0.05 0.07	-	nm/°C
Temperature coefficient of $VF$ $IF = 20mA$ , $-10$ °C $\leq T \leq 100$ °C	TCv	Red Yellow	-	-	-1.9 -1.9	-	mV/°C

#### Notes:





Spatial Distribution

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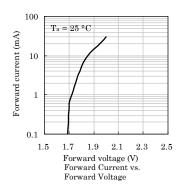
<sup>1.</sup> Wavelength: +/-1nm.

 $<sup>2.\</sup> Forward\ Voltage: \hbox{+-}0.1V.$ 

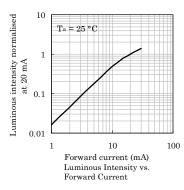
 $<sup>\ ^*</sup>$  Wavelength value is in accordance with CIE127-2007 standards.

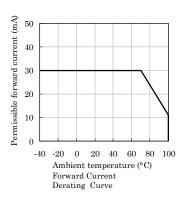


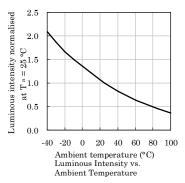
### Red



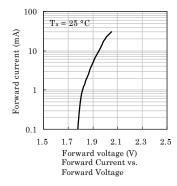
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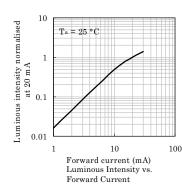


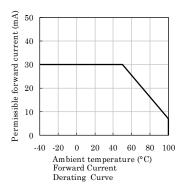


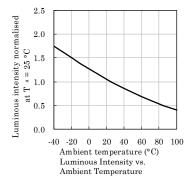


### **❖** Yellow



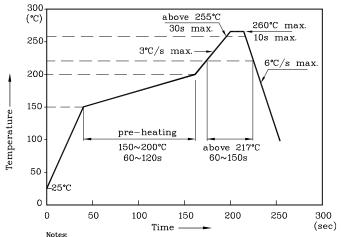






# LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)



- 1. All temperatures refer to the center of the package,
- measured on the package body surface facing up during reflow.

  2. Do not apply any stress to the LED during high temperature conditions.
- 3. Maximum number of soldering passes: 2

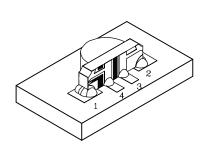




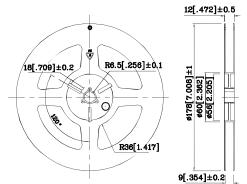
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❖ The device has a single mounting surface. The device must be mounted according to the specifications.

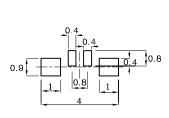
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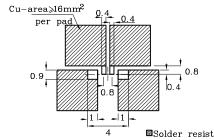


# **❖** Reel Dimension

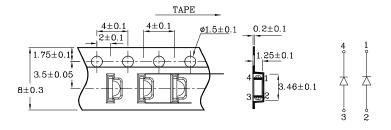


**❖** Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)





**❖** Tape Specification (Units:mm)



# Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

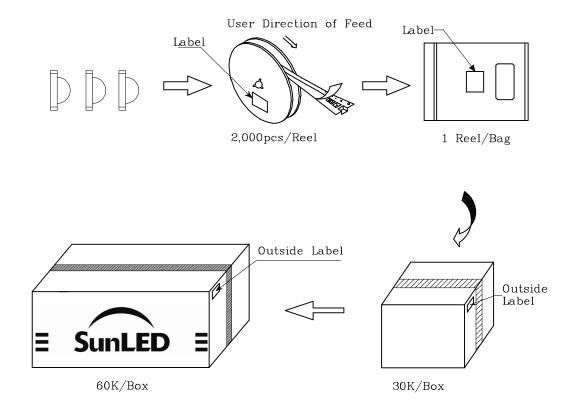
- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

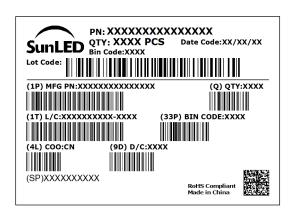
Note: Accuracy may depend on the sorting parameters.





## PACKING & LABEL SPECIFICATIONS





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# **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below

Lot Tolerance Percent Defective (LTPD): 10%

No.	Test Item	Standards	Test Condition	Test Times / Cycles	Number of Damaged
1	Continuous operating test	-	$T_a$ = 25°C, $I_F$ = maximum rated current *	1,000 h	0 / 22
2	High Temp. operating test	EIAJ ED-4701/100(101)	$T_a$ = 100°C, $I_F$ = maximum rated current *	1,000 h	0 / 22
3	Low Temp. operating test	-	$T_a$ = -40°C, $I_F$ = maximum rated current *	1,000 h	0 / 22
4	High temp. storage test	EIAJ ED-4701/100(201)	$T_a$ = maximum rated storage temperature	1,000 h	0 / 22
5	Low temp. storage test	EIAJ ED-4701/100(202)	$T_a = -40$ °C	1,000 h	0 / 22
6	High temp. & humidity storage test	EIAJ ED-4701/100(103)	$T_a = 60$ °C, RH = 90%	1,000 h	0 / 22
7	High temp. & humidity operating test	EIAJ ED-4701/100(102)	$T_a$ = 60°C, RH = 90% $I_F$ = maximum rated current *	1,000 h	0 / 22
8	Soldering reliability test	EIAJ ED-4701/100(301)	Moisture soak: 30°C, 70% RH, 72h Preheat: 150~180°C (120s max.) Soldering temp: 260°C(10s)	2 times	0 / 18
9	Thermal shock operating test	-	$\begin{split} T_a = -40 ^{\circ} C(15 min) &\sim 100 ^{\circ} C(15 min) \\ I_F = derated \ current \ at \ 100 ^{\circ} C \end{split}$	1,000 cycles	0 / 22
10	Thermal shock test	-	$T_a$ = -40°C(15min) ~ maximum rated Storage temperature(15min)	1,000 cycles	0 / 22
11	Electric Static Discharge (ESD)	EIAJ ED-4701/100(304)	$C = 100 pF$ , $R2 = 1.5 K\Omega$ V = 3000 V (Red) V = 3000 V (Yellow)	Once each Polarity	0 / 22
12	Vibration test	-	$a = 196 \text{m/s}^2$ , $f = 100 \sim 2 \text{KHz}$ , $t = 48 \text{min for all xyz axes}$	4 times	0 / 22

 $<sup>\</sup>ensuremath{^*}$  : Refer to forward current vs. derating curve diagram

# Criteria for Judging Damage

Items	Symbols	Conditions	Failure Criteria
luminous Intensity	lv	$I_F = 20 \text{mA}$	Testing Min. Value <spec.min.value 0.5<="" td="" x=""></spec.min.value>
Forward Voltage	VF	$I_F = 20 \text{mA}$	Testing Max. Value ≥Spec.Max.Value x 1.2
Reverse Current	Ir	VR = Maximum Rated Reverse Voltage	Testing Max. Value ≥Spec.Max.Value x 2.5
High temp. storage test	-	-	Occurrence of notable decoloration, deformation and cracking